

1. Description

The UMW MOC305x series devices are optocouplers composed of a GaAs infra-red light emitting diode and a singlecrystal silicon chip random phase photoelectric bidirectional thyristor.

3. Application

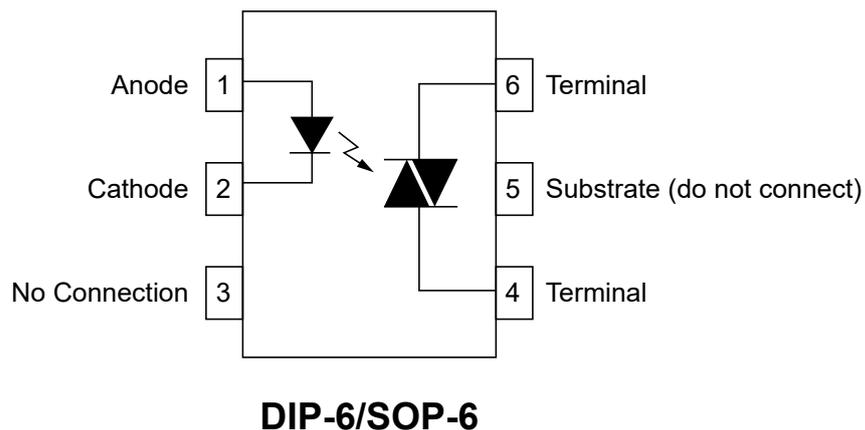
- Solenoid valve control
- Ballast
- Static AC power switch
- Incandescent lamp dimmer

2. Features

- Peak breakdown voltage 600V
- High isolation voltage between input and output($V_{ISO}=5000 V_{rms}$)
- Compact DIP (Dual In-line Package) housing
- Lead-free, RoHS compliant
- UL approved: UL1577, file No.E547318

- Microprocessor 115-240VAC peripheral interface
- Temperature control
- Motor control

4. Pinning information





5. Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Input			
Forward Current	I_F	60	mA
Backward Voltage	V_R	6	V
Power Dissipation	P_D	100	mW
Power dissipation Derating factor (above $T_a=85^\circ\text{C}$)		3.8	mW/ $^\circ\text{C}$
Output			
Off-state output terminal voltage	UMW MOC305x V_{DRM}	600	V
Peak repetitive surge current (pw=100 μs , 120pps)	I_{TSM}	1	A
On-state current (root mean square value)	$I_{T(RMS)}$	100	mA
Power Dissipation	P_C	300	mW
Power dissipation Derating factor (above $T_a=85^\circ\text{C}$)		7.4	mW/ $^\circ\text{C}$
Total Power Dissipation	P_{TOT}	330	mW
Isolation Voltage	V_{ISO}	5000	Vrms
Operating Temperature	T_{OPR}	-55 to 110	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 to 125	$^\circ\text{C}$
Soldering Temperature (10s)	T_{SOL}	260	$^\circ\text{C}$

Notes:

Conduct AC test at 40% ~60% relative humidity. At this time, pins 1, 2 and 3 are short-circuited, and pins 4, 5 and 6 are short-circuited.



6. Electro-optical Characteristics ($T_A=25^\circ\text{C}$)

Parameter	Symbol	Conditions	Min	Typ	Max	Units	
Input							
Forward Voltage	V_F	$I_F=20\text{mA}$		1.18	1.5	V	
Back current	I_R	$V_R=6\text{V}$			10	μA	
Output							
Off-state peak current	I_{DRM}	$V_{\text{DRM}}=\text{Rated } V_{\text{DRM}}, I_F=0\text{mA}$			100	nA	
On-state peak voltage	V_{TM}	$I_{\text{TM}}=100\text{mA peak}, I_F=\text{Rated } I_{\text{FT}}$			2.5	V	
Critical rise rate of off-state voltage	dv/dt	$V_{\text{PEAK}}=400\text{V}, I_F=0$	1000			V/ μs	
Transfer Characteristics							
LED trigger current	UMW MOC3051	I_{FT}	Main terminal Voltage =3V			15	mA
	UMW MOC3052					10	mA
	UMW MOC3053					5	mA
Maintain current		I_H		250		μA	

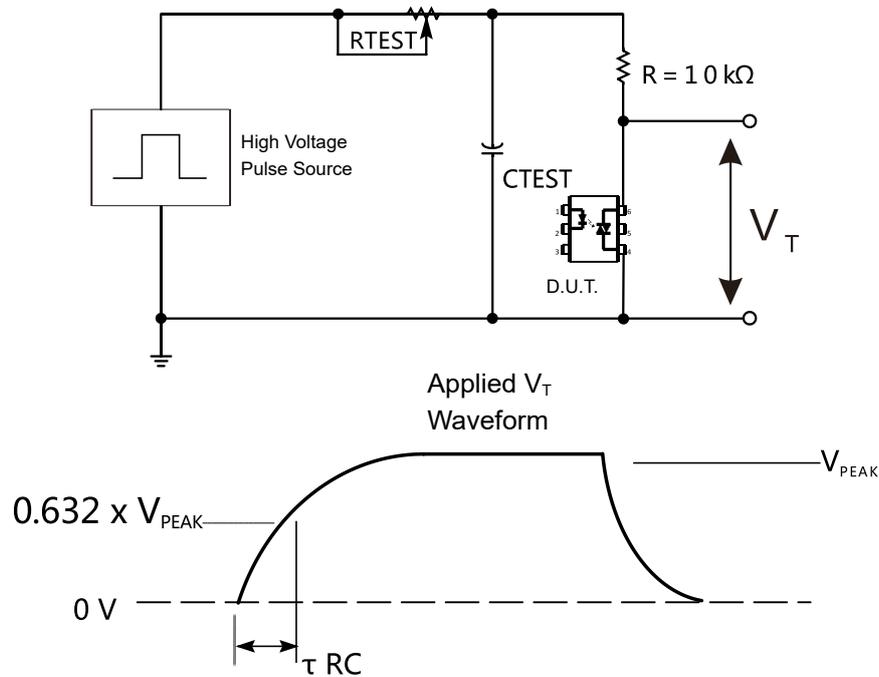


7. Typical Characteristic

<p>Figure 1: LED Forward Voltage vs. Forward Current</p>	<p>Figure 2: On-State Characteristics</p>
<p>Figure 3: Trigger Current vs. Ambient Temperature</p>	<p>Figure 4: LED Current Required to Trigger vs. LED Pulse Width</p>
<p>Figure 5: dv/dt vs. Temperature</p>	<p>Figure 6: Leakage Current, I_{DRM} vs. Temperature</p>



8.Static dv/dt test circuit and waveform



The high voltage pulse applied to the output end of the device under test through the RC circuit is set to the desired V_{PEAK} value. LED current does not need to be added. Waveform V_T is monitored with X100 probe. By adjusting the R_{TEST} value, dv/dt (slope) increases until the device under test is observed to be triggered (waveform collapse). Dv/dt then drops until the device under test stops being triggered. At this time, dv/dt can be calculated by recording the value of τRC .

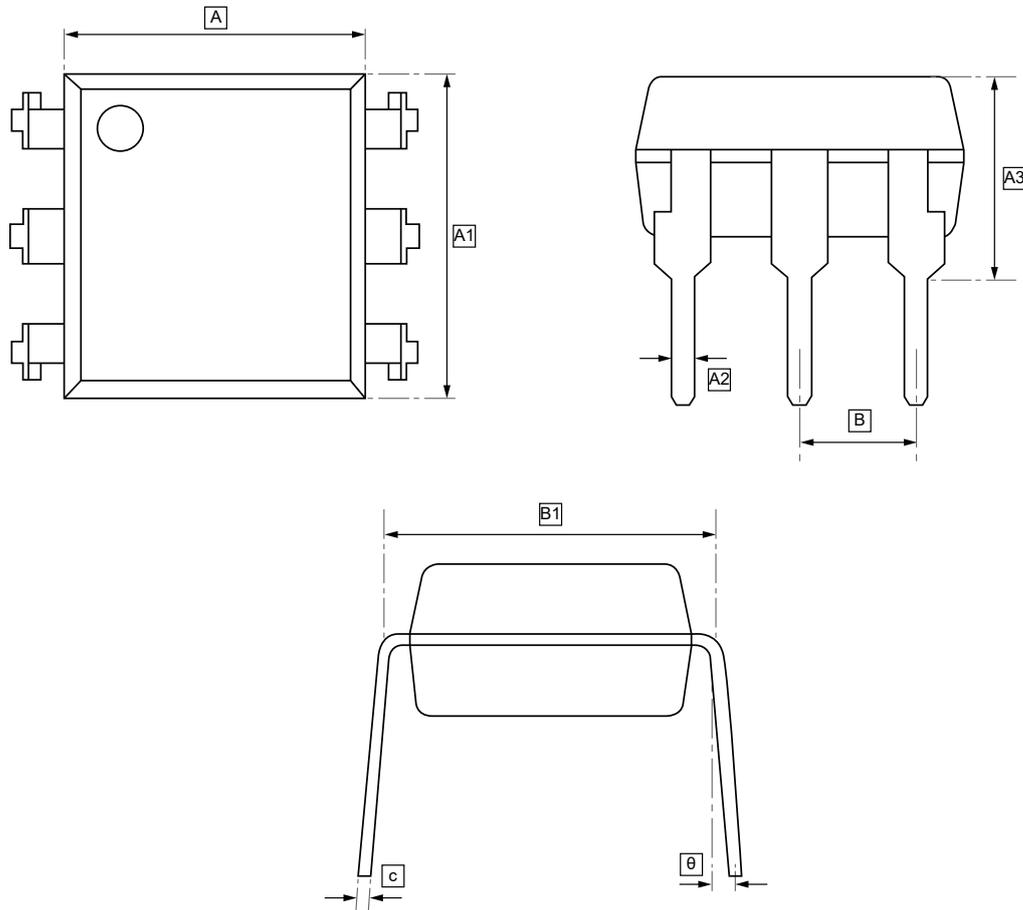
$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau RC}$$

For example, the voltage peak of UMW MOC305x series $V_{PEAK}=600V$. Then the dv/dt value can be calculated as follows:

$$dv/dt = \frac{0.632 \times 600}{\tau RC} = \frac{379}{\tau RC}$$



9.1 DIP-6 Package Outline Dimensions

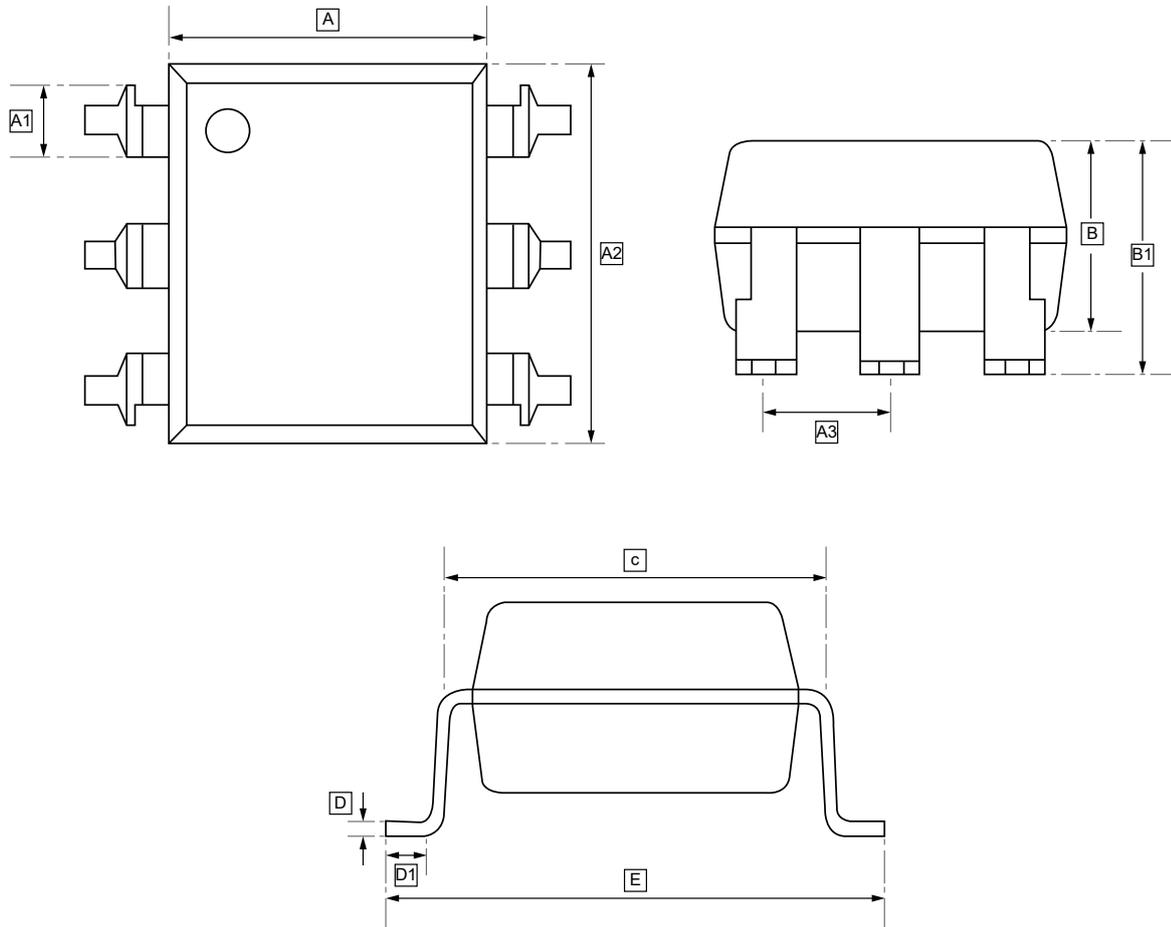


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	A3	B	B1	c	θ
Min	6.20	6.82	0.40	4.20	2.54	7.62	0.25	5°
Max	6.80	7.42	0.60	4.80	TYP	TYP		15°



9.2SOP-6 Package Outline Dimensions

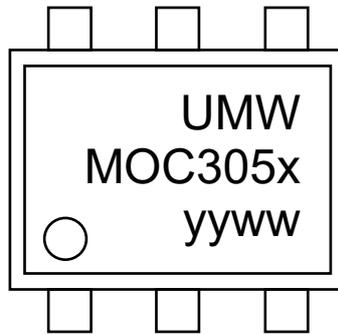


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	A3	B	B1	c	D	D1	E
Min	6.20	1.30	6.82	2.54	3.20	4.00	7.62	0.25	0.60	-
Max	6.80		7.42		TYP					3.80



10. Ordering information



yy: Year Code
ww: Week Code

Order Code	Marking	Package	Base QTY	Delivery Mode
UMW MOC3051M	MOC3051	DIP-6	3250	Tape and reel
UMW MOC3052M	MOC3052	DIP-6	3250	Tape and reel
UMW MOC3052SM	MOC3052	SOP-6	1000	Tape and reel
UMW MOC3053M	MOC3053	DIP-6	3250	Tape and reel
UMW MOC3053SM	MOC3053	SOP-6	1000	Tape and reel



11.Disclaimer

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